

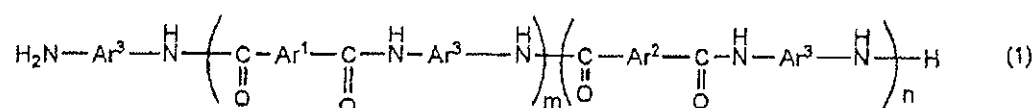
Abstract

[PROBLEMS]

To provide a process for producing a printed board having sufficient heat resistance.

[MEANS FOR SOLVING PROBLEMS]

The process for double-sided flexible printed board production comprising: a step in which a varnish comprising an aromatic resin represented by the following formula (1), an epoxy resin, and an organic solvent is directly applied to a metal foil; a step in which the solvent is removed to form a resin layer; and a step in which another foil is applied to the resin-layer side and the resin layer is cured.



(In the formula, m and n are average value, m+n is a positive number of 2-200, and n is a positive number of 0.1 or larger; Ar¹ and Ar³ each is a divalent aromatic group; and Ar² is a divalent residue having a phenolic hydroxy group.)